

● General Description

The AGM40P25A combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$.

This device is ideal for load switch and battery protection applications.

● Features

- Advance high cell density Trench technology
- Low $R_{DS(ON)}$ to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance
- 100% Avalanche tested
- 100% DVDS tested

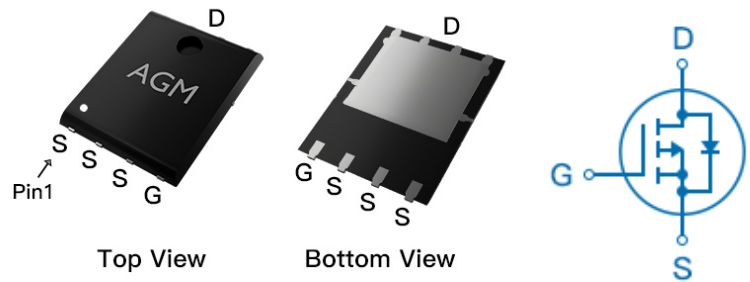
● Application

- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver

Product Summary

| BVDSS | RDSON | ID |
|-------|-------|------|
| -40V | 32mΩ | -19A |

PDFN5*6 Pin Configuration



Package Marking and Ordering Information

| Device Marking | Device | Device Package | Reel Size | Tape width | Quantity |
|----------------|-----------|----------------|-----------|------------|----------|
| AGM40P25A | AGM40P25A | PDFN5*6 | 330mm | 12mm | 3000 |

Table 1. Absolute Maximum Ratings (TA=25°C)

| Symbol | Parameter | Value | Unit |
|-------------|---|------------|------|
| VDS | Drain-Source Voltage (VGS=0V) | -40 | V |
| VGS | Gate-Source Voltage (VDS=0V) | ±20 | V |
| ID | Drain Current-Continuous(Tc=25°C) (Note 1) | -19 | A |
| | Drain Current-Continuous(Tc=100°C) | -13 | A |
| IDM (pulse) | Drain Current-Continuous@ Current-Pulsed (Note 2) | -76 | A |
| PD | Maximum Power Dissipation(Tc=25°C) | 40 | w |
| | Maximum Power Dissipation(Tc=100°C) | 20 | w |
| EAS | Avalanche energy (Note 3) | 64 | mJ |
| TJ,TSTG | Operating Junction and Storage Temperature Range | -55 To 175 | °C |

Table 2. Thermal Characteristic

| Symbol | Parameter | Typ | Max | Unit |
|--------|---|-----|-----|------|
| RθJA | Thermal Resistance Junction-ambient (Steady State) ¹ | --- | 20 | °C/W |
| RθJC | Thermal Resistance Junction-Case ¹ | --- | 3.7 | °C/W |

Table 2. P-Channel Electrical Characteristics (T_J=25°C unless otherwise noted)

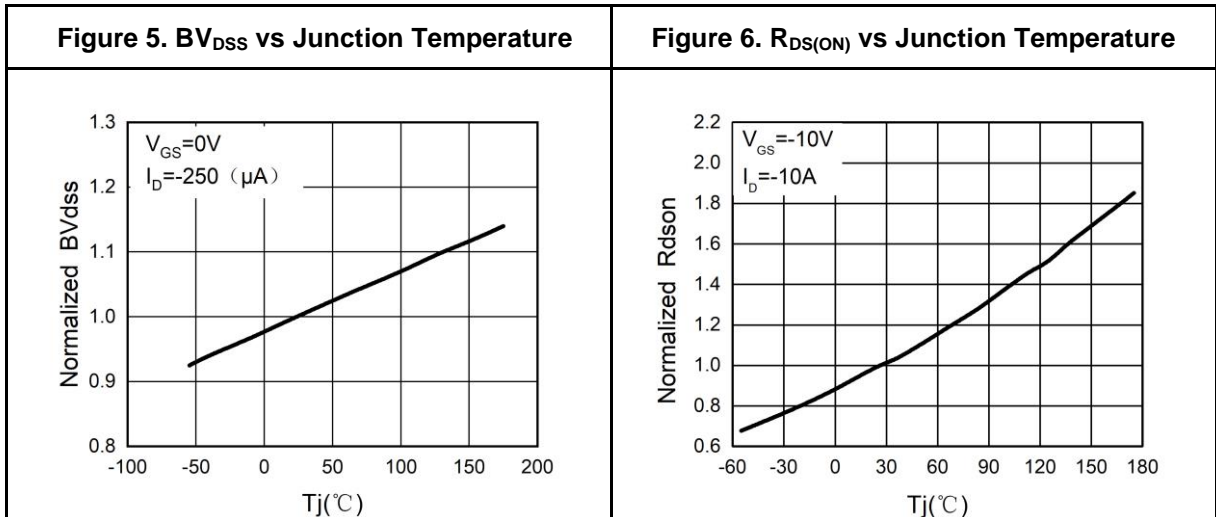
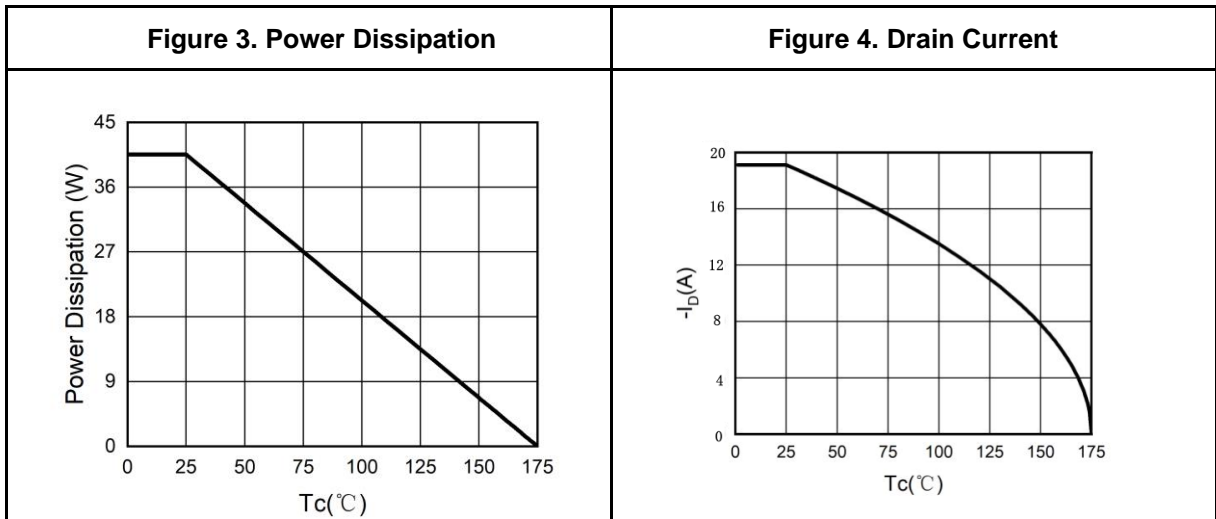
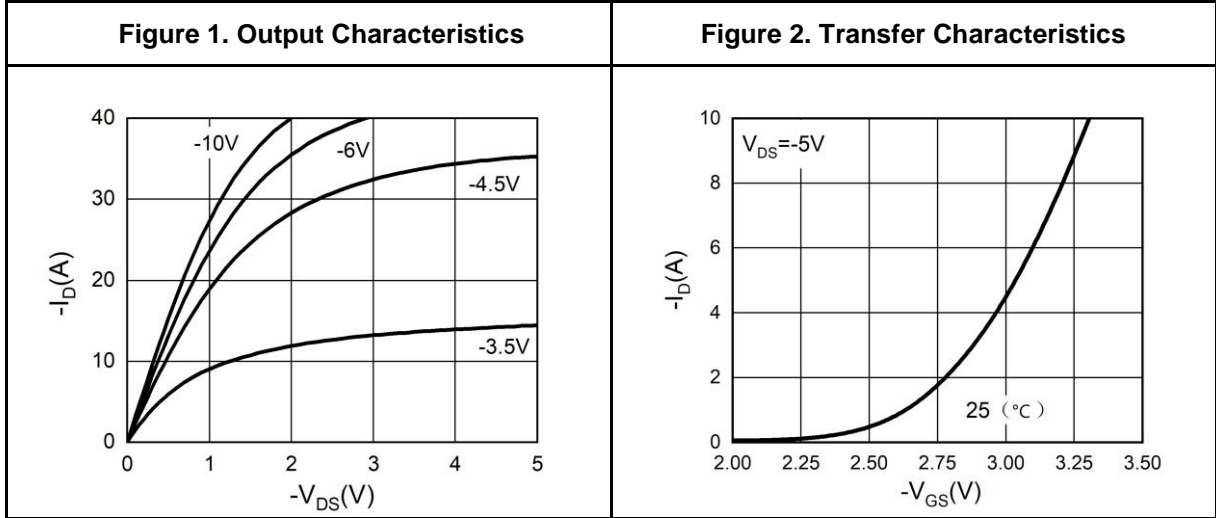
| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|----------------------------------|---------------------------------------|------|------|------|------|
| On/Off States | | | | | | |
| BVDSS | Drain-Source Breakdown Voltage | VGS=0V ID=-250μA | -40 | -- | -- | V |
| IDSS | Zero Gate Voltage Drain Current | VDS=-40V, VGS=0V | -- | -- | -1 | μA |
| IGSS | Gate-Body Leakage Current | VGS=±20V, VDS=0V | -- | -- | ±100 | nA |
| VGS(th) | Gate Threshold Voltage | VDS=VGS, ID=-250μA | -1.2 | -- | -2.2 | V |
| gFS | Forward Transconductance | VDS=-5V, ID=-5A | -- | 11 | -- | S |
| RDS(on) | Drain-Source On-State Resistance | VGS=-10V, ID=-10A | -- | 32 | 36 | mΩ |
| | | VGS=-4.5V, ID=-5A | -- | 42 | 47 | mΩ |
| Dynamic Characteristics | | | | | | |
| Ciss | Input Capacitance | VDS=-20V, VGS=0V, F=1MHZ | -- | 1021 | -- | pF |
| Coss | Output Capacitance | | -- | 63.6 | -- | pF |
| Crss | Reverse Transfer Capacitance | | -- | 48.6 | -- | pF |
| Rg | Gate resistance | VGS=0V, VDS=0V, f=1.0MHz | -- | 4.7 | -- | Ω |
| Switching Times | | | | | | |
| td(on) | Turn-on Delay Time | VGS=-10V, VDS=-20V, RL=2Ω, RGEN=3Ω | -- | 13 | -- | nS |
| tr | Turn-on Rise Time | | -- | 16 | -- | nS |
| td(off) | Turn-Off Delay Time | | -- | 180 | -- | nS |
| tf | Turn-Off Fall Time | | -- | 86 | -- | nS |
| Qg | Total Gate Charge | VGS=-10V, VDS=-20V, ID=-10A | -- | 19.3 | -- | nC |
| Qgs | Gate-Source Charge | | -- | 2.5 | -- | nC |
| Qgd | Gate-Drain Charge | | -- | 5.5 | -- | nC |
| Source-Drain Diode Characteristics | | | | | | |
| ISD | Source-Drain Current(Body Diode) | | -- | -- | -19 | A |
| VSD | Forward on Voltage | VGS=0V, IS=-10A | -- | -- | -1.2 | V |
| trr | Reverse Recovery Time | IF=-10A , dI/dt=100A/μs , TJ=25°C | -- | 34 | -- | ns |
| Qrr | Reverse Recovery Charge | | -- | 35 | -- | nc |

Notes 1.The maximum current rating is package limited.

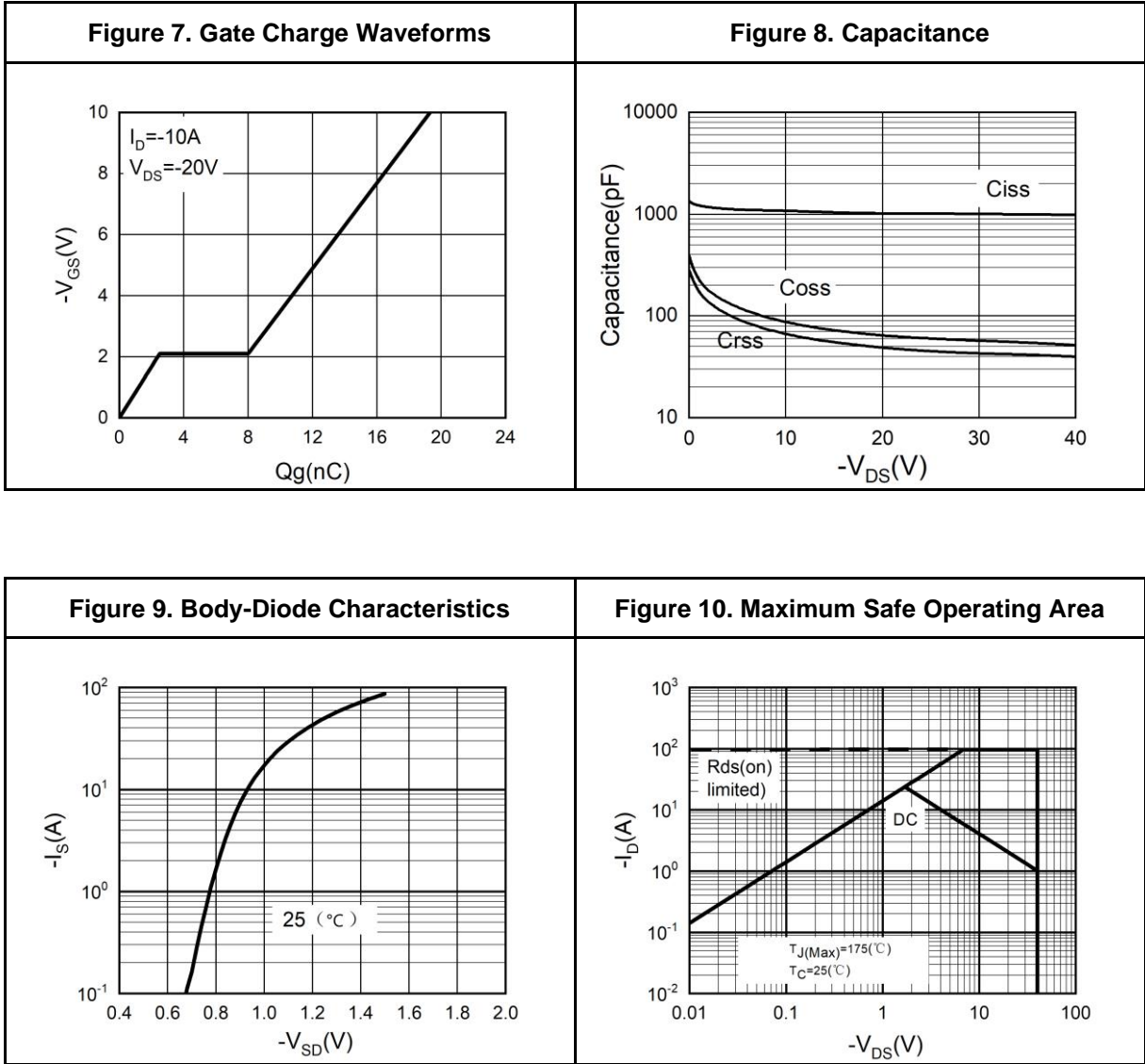
Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature Notes

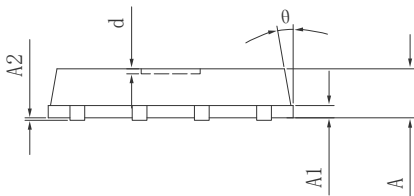
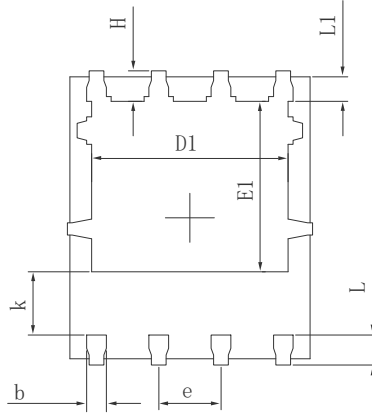
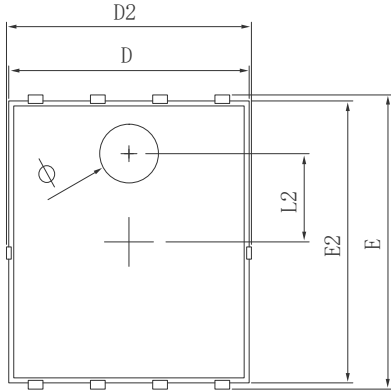
3.EAS condition: T_J=25°C, VDD=-25V, Vgs=-10V, ID=-16A, L=0.5mH, RG=25ohm

Typical Electrical And Thermal Characteristics (Curves)

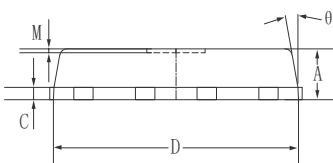
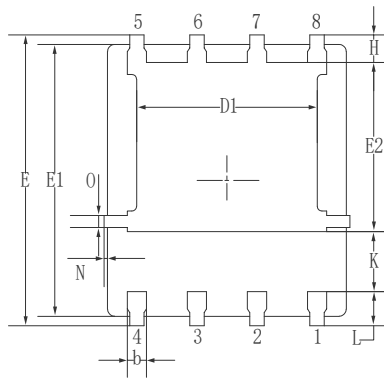
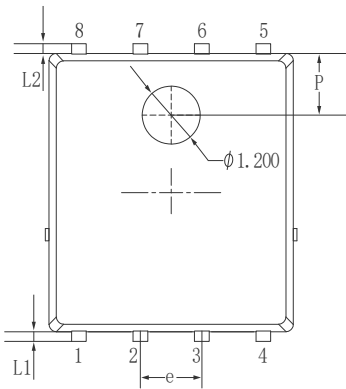


Typical Electrical And Thermal Characteristics (Curves)



•Dimensions (PDFN5*6)


| SYMBOL | MILLIMETER | | |
|--------|------------|-------|-------|
| | MIN. | TYP. | MAX. |
| A | 0.900 | 1.000 | 1.100 |
| A1 | 0.254 REF. | | |
| A2 | 0~0.05 | | |
| D | 4.824 | 4.900 | 4.976 |
| D1 | 3.910 | 4.010 | 4.110 |
| D2 | 4.924 | 5.000 | 5.076 |
| E | 5.924 | 6.000 | 6.076 |
| E1 | 3.375 | 3.475 | 3.575 |
| E2 | 5.674 | 5.750 | 5.826 |
| b | 0.350 | 0.400 | 0.450 |
| e | 1.270 TYP. | | |
| L | 0.534 | 0.610 | 0.686 |
| L1 | 0.424 | 0.500 | 0.576 |
| L2 | 1.800 REF. | | |
| k | 1.190 | 1.290 | 1.390 |
| H | 0.549 | 0.625 | 0.701 |
| theta | 8° | 10° | 12° |
| phi | 1.100 | 1.200 | 1.300 |
| d | | | 0.100 |

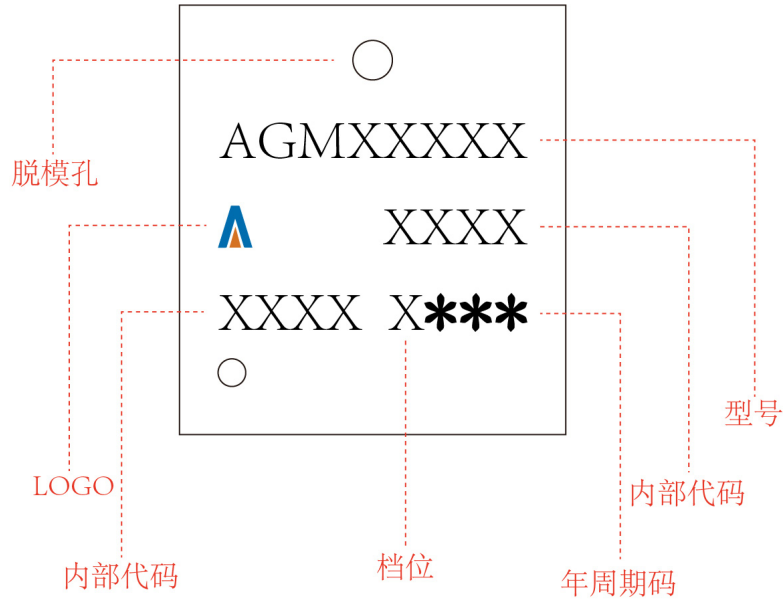


| SYMBOL | MILLIMETER | | |
|--------|------------|------|------|
| | MIN. | NOM. | MAX. |
| A | 0.90 | 1.05 | 1.20 |
| b | 0.35 | 0.40 | 0.50 |
| C | 0.20 | 0.25 | 0.35 |
| D | 4.90 | 5.05 | 5.20 |
| D1 | 3.72 | 3.82 | 3.92 |
| E | 6.00 | 6.15 | 6.30 |
| E1 | 5.60 | 5.75 | 5.90 |
| E2 | 3.47 | 3.57 | 3.67 |
| e | 1.27 BSC. | | |
| H | 0.48 | 0.58 | 0.68 |
| K | 1.17 | 1.27 | 1.37 |
| L | 0.64 | 0.74 | 0.84 |
| L1/L2 | 0.20 REF. | | |
| theta | 8° | 10° | 12° |
| M | 0.08 REF. | | |
| N | 0 | - | 0.15 |
| O | 0.25 REF. | | |
| P | 1.28 REF. | | |

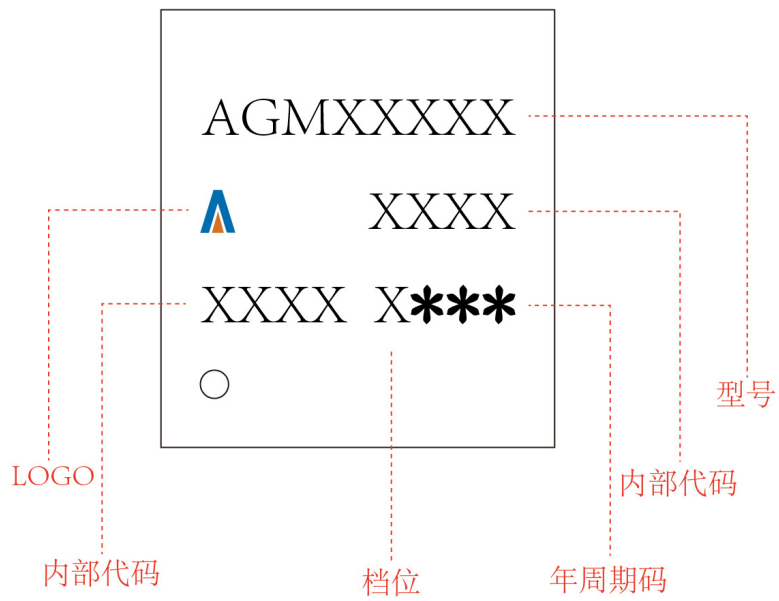
PDFN5*6

Marking Instructions:

Model1:



Model2:



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